

# **PXC-M03 Single Output Series: DC-DC Converter Module**

4.5 ~ 9 VDC, 9 ~ 18 VDC, 18 ~ 36 VDC and 36~ 75 VDC input; 3.3 to 24 VDC Single Output 3 Watts Output Power



#### **FEATURES**

- SINGLE OUTPUT UP TO 1A
- REINFORCED INSULATION FOR 250VAC WORKING VOLTAGE
- CLEARANCE AND CREEPAGE DISTANCE: 8.0mm/2MOPP
- 5000VAC INPUT TO OUTPUT 2MOPP ISOLATION
- NO MINIMUM LOAD REQUIRED
- HIGH EFFICIENCY UP TO 87%
- BUILT-IN EMI CLASS A FILTER
- 2µA PATIENT LEAKAGE CURRENT
- SMALL SIZE: 1.25 × 0.80 × 0.40 INCH
- 2:1 ULTRA WIDE INPUT VOLTAGE RANGE
- FIXED SWITCHING FREQUENCY
- INPUT UNDER-VOLTAGE PROTECTION
- OUTPUT OVER-VOLTAGE PROTECTION
- OVER-CURRENT PROTECTION
- OUTPUT SHORT CIRCUIT PROTECTION
- REMOTE ON/OFF
- COMPLIANT TO RoHS II & REACH

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CE MARKED SAFETY APPROVALS:

ANSI/AAMI ES60601-1

EN60601-1 IEC60601-1

#### **APPLICATIONS**

- MEDICAL EQUIPMENT
- TELECOM/DATACOM
- INDUSTRY CONTROL SYSTEM
- MEASUREMENT EQUIPMENT
- SEMICONDUCTOR EQUIPMENT
- PV POWER SYSTEM
- IGBT GATE DRIVER

#### **OPTIONS**

- PIN CONNECTION
- REMOTE ON/OFF
- TRIM

#### **GENERAL DESCRIPTIONS**

The PXC-M03 series offer 3 watts of output power from a 1.25 x 0.80 x 0.40 inch package. PXC-M03 series have 2:1 wide input voltage of 4.5~9VDC, 9~18VDC, 18~36VDC and 36~75VDC. The PXC-M03 has features 5000VAC of isolation, short circuit protection, over-current protection and over-voltage protection. All models are particularly suited to IGBT isolated power supplies, measurement equipment, telecommunications, industry and medical equipment applications.



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Output Specifications							
Parameter	Model	Min	Тур	Max	Unit		
Output Voltage	xxS3P3	3.267	3.3	3.333			
(Vin(nom); Full Load; Ta=25°C)	xx <b>S05</b>	4.95	5	5.05			
	xxS12	11.88	12	12.12	VDC		
	xxS15	14.85	15	15.15			
	xx <b>S24</b>	23.76	24	24.24			
Output Regulation							
Line (Vin(min) to Vin(max); Full Load)	All	-0.2		+0.2	%		
Load (0% to 100% of Full Load)		-0.2		+0.2			
Output Ripple and Noise							
Peak to Peak (20MHz Bandwidth)							
With a 10µF/25V X7R MLCC	xxS3P3		30	75			
·	xx <b>S05</b>		30	75			
	xx <b>S12</b>		40	100	mVp-p		
	xx <b>S15</b>		40	100			
	1111010						
With a 4.7µF/50V X7R MLCC	xx <b>S24</b>		50	100			
Voltage adjustability (see page 46)	xx <b>S3P3-T</b>	-10		+10			
(Only for B-type Pin connection option)	xx <b>S</b> 05- <u>T</u>	-10		+10			
(0)	xx <b>S</b> 12- <b>T</b>	-10		+10	% of Vout		
	xxS15- <b>T</b>	-10		+20	70 01 1041		
	xxS24- <u>T</u>	-10		+20			
Temperature Coefficient	AII	-0.02		+0.02	%/°C		
Output Voltage Overshoot		0.02					
(Vin,min to Vin,max; Full Load; Ta=25°C)	All		0	3	% of Vout		
Dynamic Load Response							
(Vin= Vin(nom); Ta=25°C)							
Load step change from							
75% to 100% or 100 to 75% of Full Load							
Peak Deviation	All		3		% of Vout		
Setting Time (Vo<10% peak deviation)	All		250		μs		
Output Current	xxS3P3	0		1000	μο		
ou.put ouriont	xxS05	0		600			
	xx <b>S</b> 12	0		250	mA		
	xxS15	0		200	11173		
	xx <b>S24</b>	0		125			
Output Capacitance Load	xx <b>S3P3</b>	U		1050			
στιραί σαρασιαπος Εσασ	xx <b>S</b> 05			750			
	xxS12			130	μF		
	xx <b>S15</b>			100			
	xxS24			39	-		
Output Over Voltage Protection (see page 48)	xxS3P3	3.7		5	1		
	xx <b>S05</b>	5.6		7.0			
	xx <b>S12</b>	13.5		16	VDC		
	xxS15	18.3		22.0			
	xx <b>S24</b>	29.1		34.5			
Output Over Current Protection (see page 48) (% of lout rated; Hiccup mode)	All		150		% of FL		
Output Short Circuit Protection (see page 48)	ΔΙΙ	All Continuous, automatic recovery					
output Short Circuit Frotection (See page 40)	All Continuous, automatic recovery						



Inpu	t Specifications				
Parameter	Model	Min	Тур	Max	Unit
Operating Input Voltage					
Continuous	<b>05S</b> xx	4.5	5	9	
	12 <b>S</b> xx	9	12	18	
	<b>24S</b> xx	18	24	36	
	48 <b>S</b> xx	36	48	75	VDC
Transient (3sec,max)	<b>05S</b> xx			16	
	12 <b>S</b> xx			25	
	<b>24S</b> xx			50	
	48Sxx			100	
Input Standby Current	05S3P3		10		
(Typ. value at Vin(nom); No Load)	05S05		10		
	05S12		15		
	05S15		15		
	05S24		20		
	12S3P3		10		
	12S05		10		
	12S12		10		
	12S15		10		
	12S24		10		
	24S3P3		6		mA
	24S05		6		
	24S12		6		
	24S15		6		
	24\$24		6		
	48S3P3		4		
	48S05		4		
	48S12		4		
	48S15		4		
	48S24		4		
Under Voltage Lockout Turn-on Threshold	05Sxx			4.5	
blider voltage Lockout fulli-on filleshold	12 <b>S</b> xx			9	
	24 <b>S</b> xx			18	VDC
	48Sxx			36	
Under Voltage Lockout Turn-off Threshold	05 <b>S</b> xx		4	30	
onder voltage Lockout fulli-on filleshold	12Sxx		8		
	24Sxx		16		VDC
	48Sxx		33		
Input reflected ripple current					
(5 to 20MHz, 12μH source impedance)	All		20		mAp-p
Start Up Time					
(Vin(nom) and constant resistive load)					
Power up	All		30		ms
Remote ON/OFF			30		
Remote ON/OFF Control B Type (see page 49)					I
(The Ctrl pin voltage is referenced to negative input)	_				
Ctrl pin Low Voltage, Module ON	xxSxx- <u>P</u>		Short or 0	~ 1.2VDC	
Ctrl pin High Voltage, Module OFF				2 ~ 12VDC	
Input Current of Remote Control Pin		-0.5	Sp011 01 Z.	1	mA
Remote Off State Input Current		5.0	2.5		mA



General Specifications							
Parameter	Model	Min	Тур	Max	Unit		
Efficiency	05S3P3						
(Vin(nom); Full Load; Ta=25°C)	05S05						
	05S12						
	05S15						
	05S24		85.5				
	12S3P3		82				
	12S05		84.5				
	12S12		87				
	12S15		87				
	12S24		87		%		
	24S3P3		82		/0		
	24S05		84.5				
	24S12		87				
	24S15		87				
	24S24		87				
	48S3P3		81				
	48S05	84 87 86.5					
	48S12						
	48S15						
	48S24		86.5				
Isolation voltage (1 minute)	All				VAC		
Input to Output		5000					
Isolation capacitance	All		12	17	pF		
Leakage current (240VAC,60Hz)	All			2	μΑ		
Switching Frequency	All	135	150	165	kHz		
Clearance/Creepage	All	8			mm		
Weight	All		14.0		g		
MTBF(see page 54)	All				hours		
MIL-HDBK-217F Ta=25°C, Full load	All	6.444 X 10°					
Safety Approvals	All	ANSI/AAMI ES60601-1					
	IEC60601-1, EN60601-1						
Case Material		Non-conductive black plastic					
Base Material	All	Non-conductive black plastic					
Potting Material	All	Silicone (UL94 V-0)					

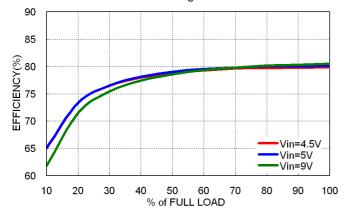
Environmental Specifications						
Parameter	Model	Min	Тур	Max	Unit	
Operating Ambient Temperature						
Without Derating	All	-40		94	°C	
With Derating		94		105		
Storage Temperature	All	-55		125	°C	
Thermal Impedance (20LFM)	All		18		°C/W	
Relative humidity	All	5		95	% RH	
Thermal Shock	All	MIL-STD-810F				
Vibration	All	MIL-STD-810F				

EMC Characteristics							
Characteristic	Standard	Cond	Level				
EMI	EN55011		Class A				
	EN55022	Module st					
	FCC Part 18						
	EN55011		Class B				
	EN55022	With externa					
	FCC Part 18						
ESD	EN61000-4-2	Air	±8kV	Perf. Criteria A			
		Contact	±6kV	r en. Ontena A			
Radiated Immunity	EN61000-4-3		10V/m	Perf. Criteria A			
Fast Transient(see page 50)	EN61000-4-4		±2kV	Perf. Criteria A			
Surge(see page 50)	EN61000-4-5		±2kV	Perf. Criteria A			
Conducted Immunity	EN61000-4-6		10V r.m.s	Perf. Criteria A			

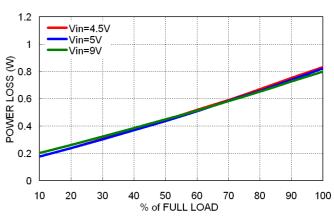


# Characteristic Curves

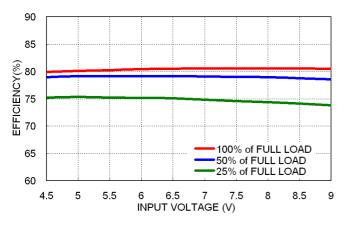
All test conditions are at 25°C. The figures are for PXC-M03-05S3P3



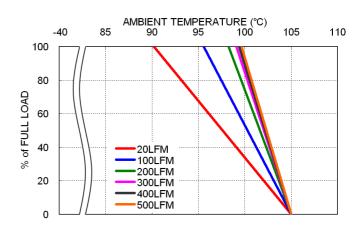
Efficiency versus Output Current



Power Dissipation versus Output Current



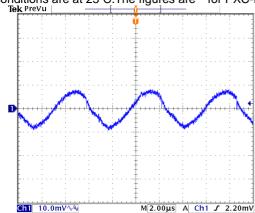
Efficiency versus Input Voltage Full Load



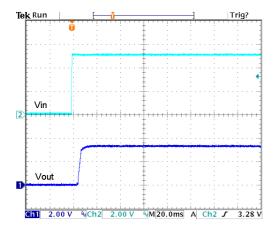
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



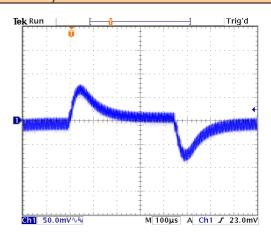
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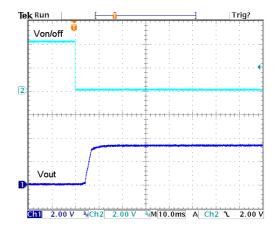
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

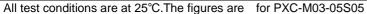


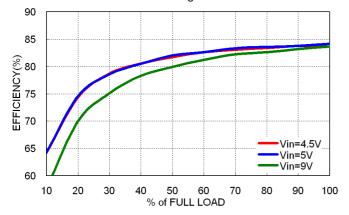
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



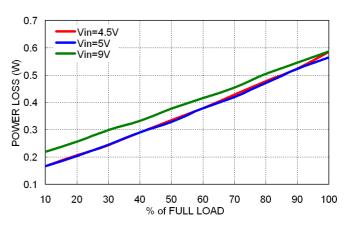
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



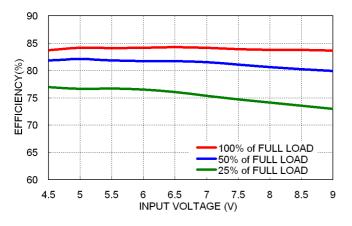




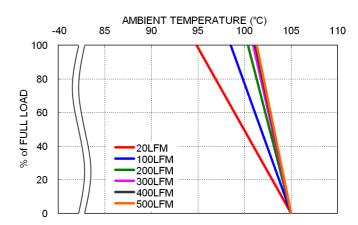
Efficiency versus Output Current



Power Dissipation versus Output Current

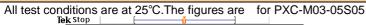


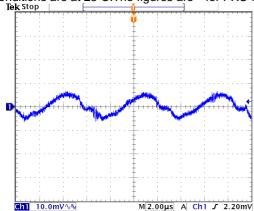
Efficiency versus Input Voltage Full Load



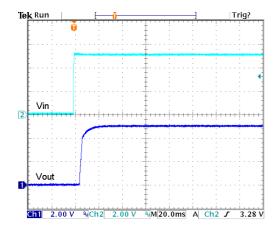
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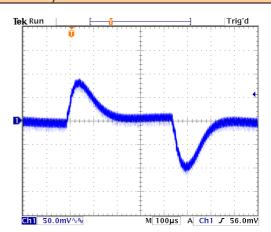




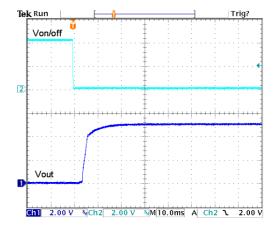
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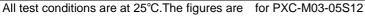


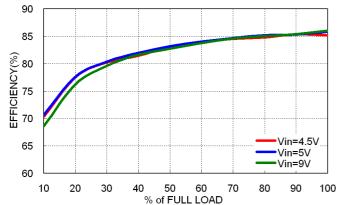
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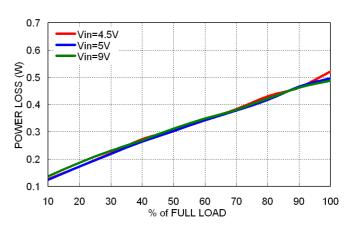
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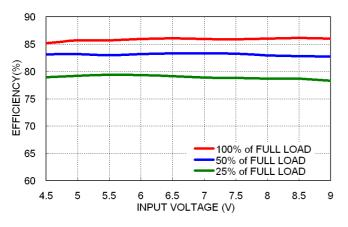




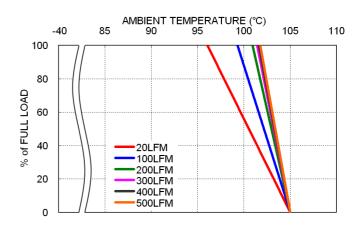
Efficiency versus Output Current



Power Dissipation versus Output Current

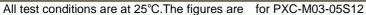


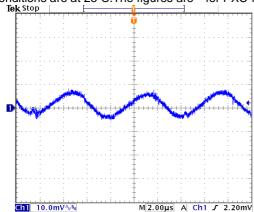
Efficiency versus Input Voltage Full Load



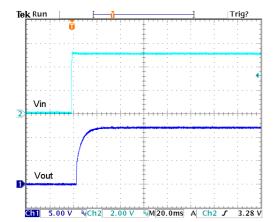
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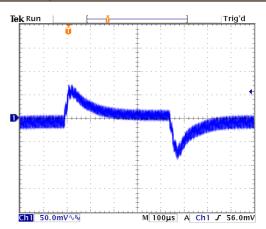




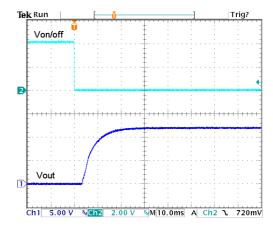
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Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

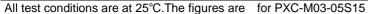


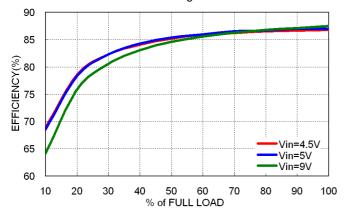
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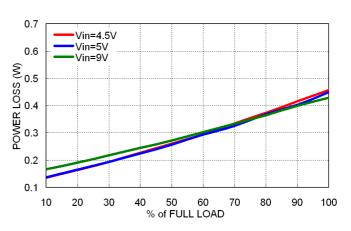
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



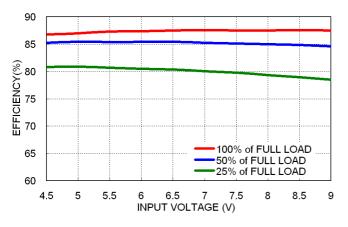




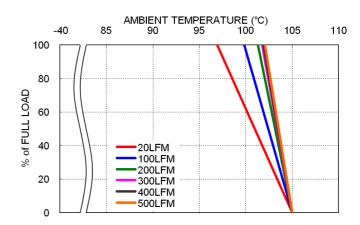
Efficiency versus Output Current



Power Dissipation versus Output Current

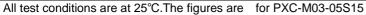


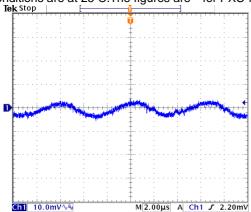
Efficiency versus Input Voltage Full Load



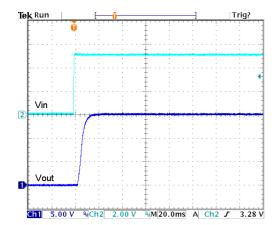
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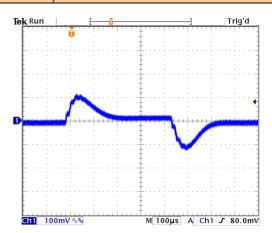




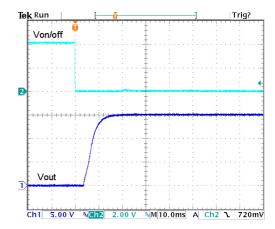
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



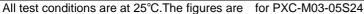
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

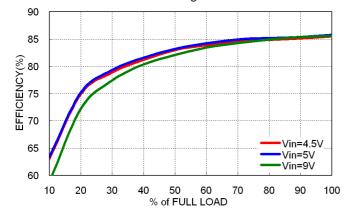


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

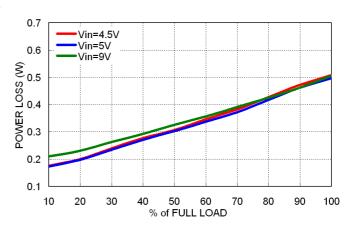
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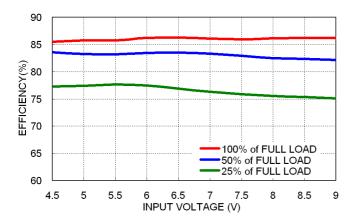




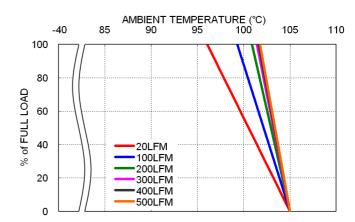
Efficiency versus Output Current



Power Dissipation versus Output Current



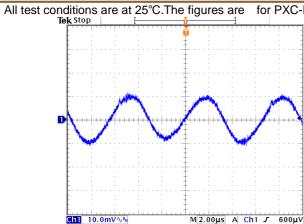
Efficiency versus Input Voltage Full Load



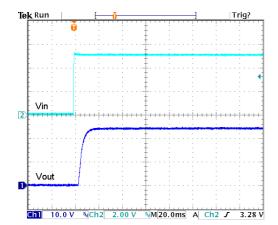
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



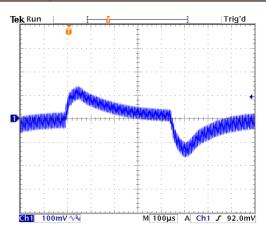
for PXC-M03-05S24



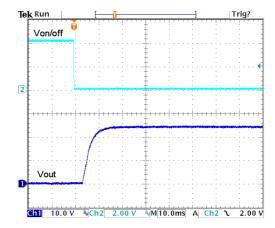
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

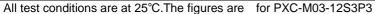


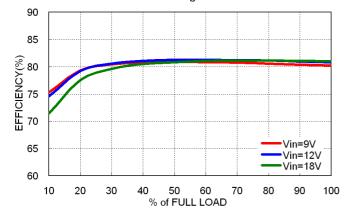
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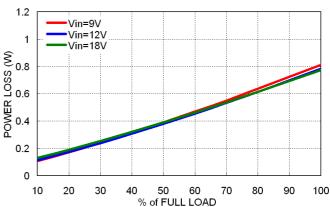
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



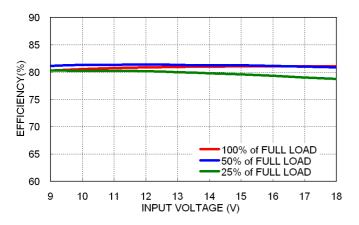




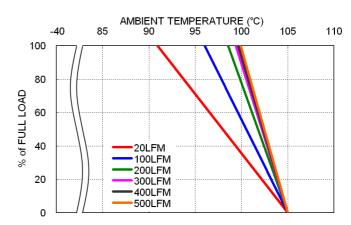
Efficiency versus Output Current



Power Dissipation versus Output Current



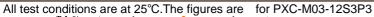
Efficiency versus Input Voltage Full Load

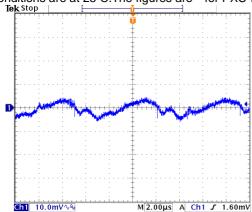


Derating Output Current versus Ambient Temperature and Airflow Vin(nom)

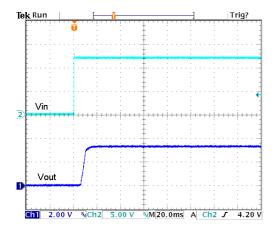
16



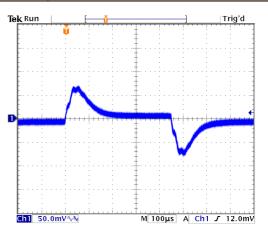




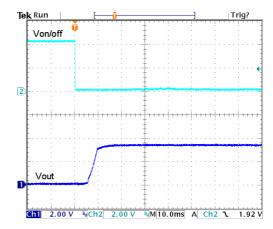
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

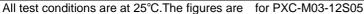


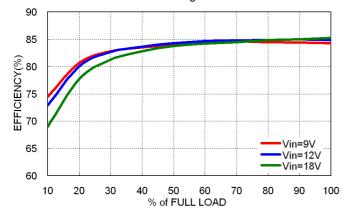
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



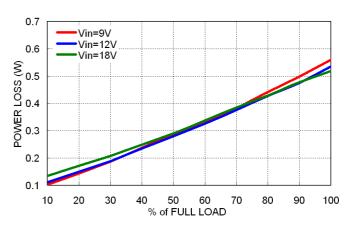
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



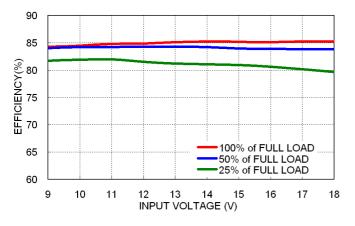




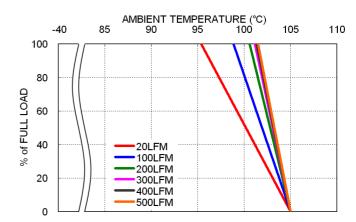
Efficiency versus Output Current



Power Dissipation versus Output Current

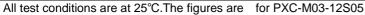


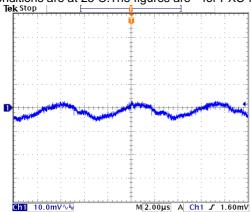
Efficiency versus Input Voltage Full Load



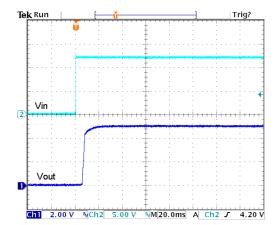
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



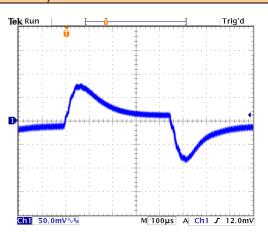




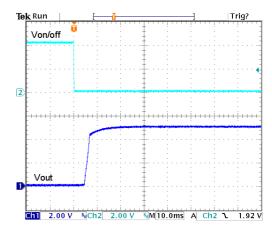
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



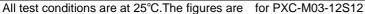
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)

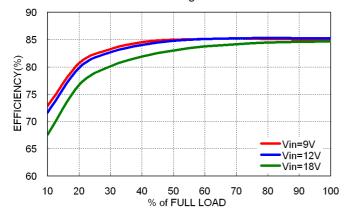


Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

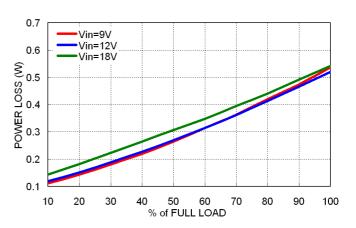
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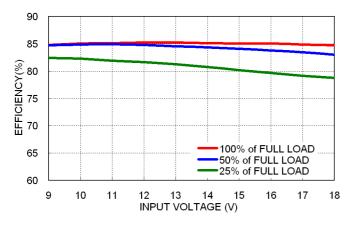




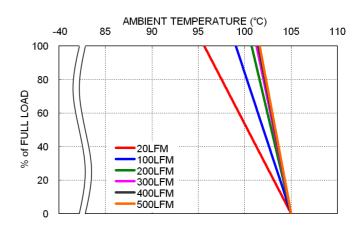
Efficiency versus Output Current



Power Dissipation versus Output Current



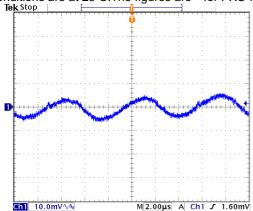
Efficiency versus Input Voltage Full Load



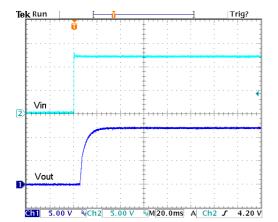
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



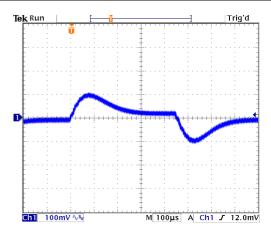




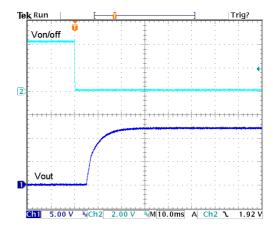
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

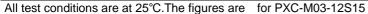


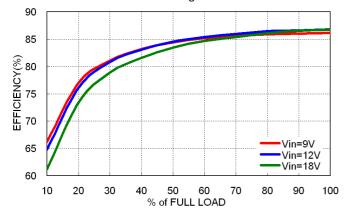
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



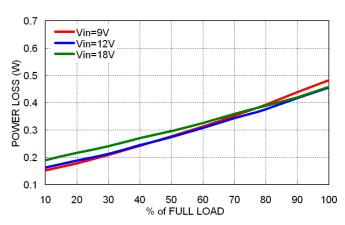
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



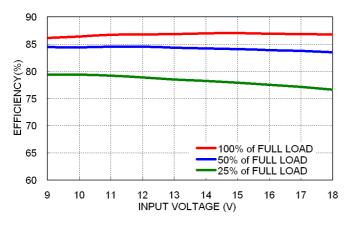




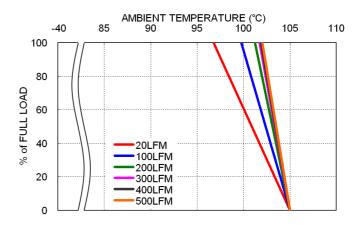
Efficiency versus Output Current



Power Dissipation versus Output Current



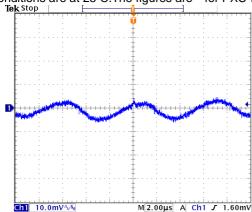
Efficiency versus Input Voltage Full Load



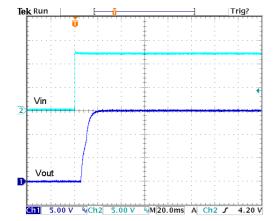
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



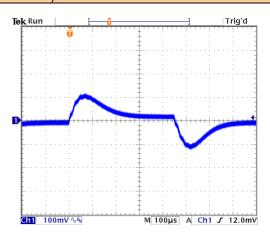




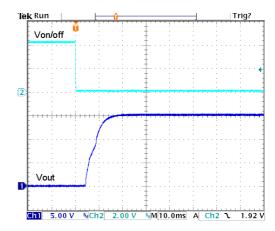
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

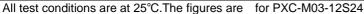


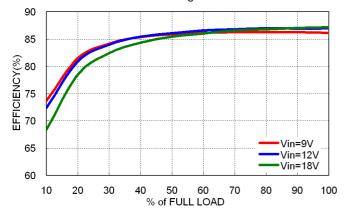
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



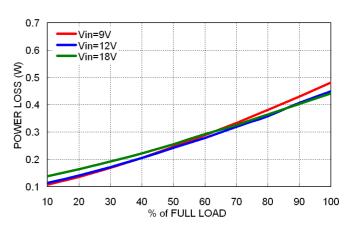
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



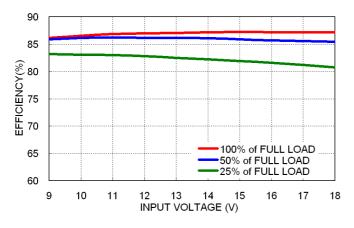




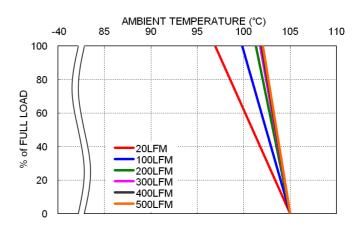
Efficiency versus Output Current



Power Dissipation versus Output Current

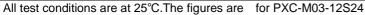


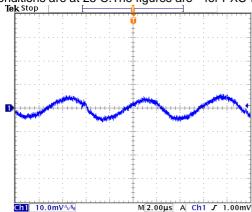
Efficiency versus Input Voltage Full Load



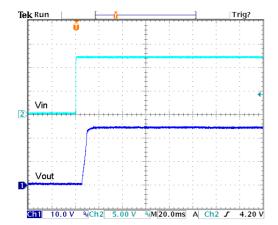
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



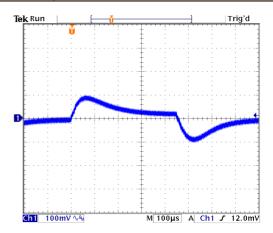




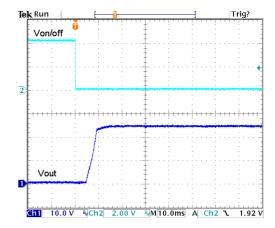
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

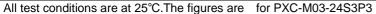


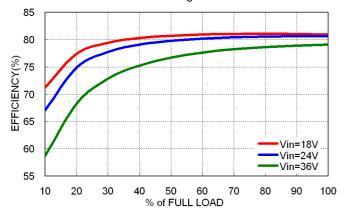
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



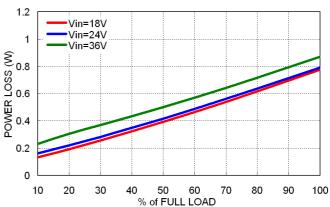
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



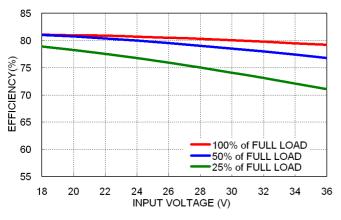




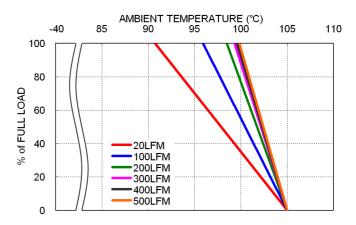
Efficiency versus Output Current



Power Dissipation versus Output Current

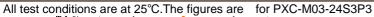


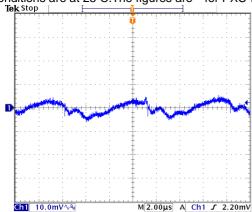
Efficiency versus Input Voltage Full Load



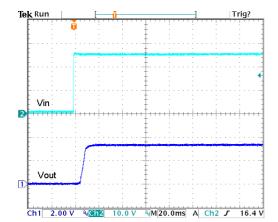
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



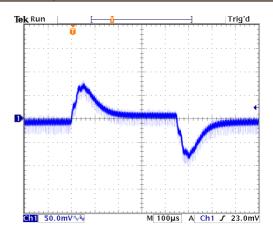




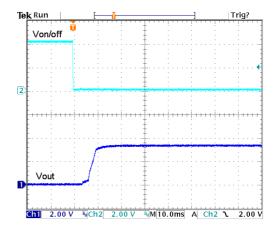
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

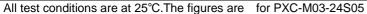


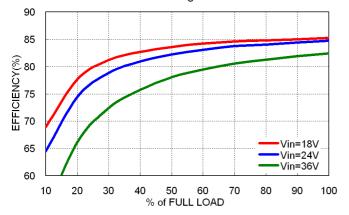
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



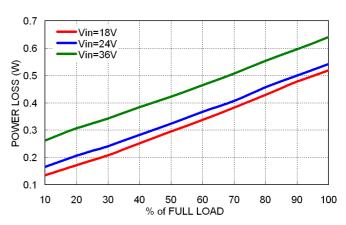
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



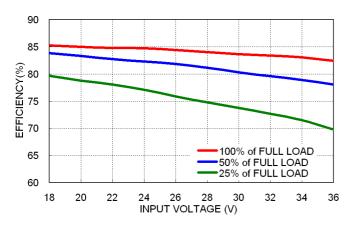




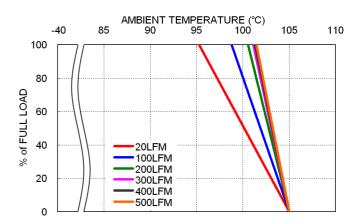
Efficiency versus Output Current



Power Dissipation versus Output Current

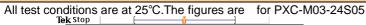


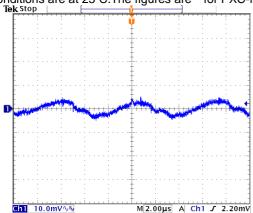
Efficiency versus Input Voltage Full Load



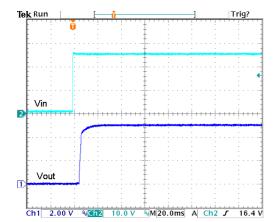
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



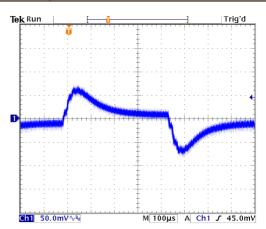




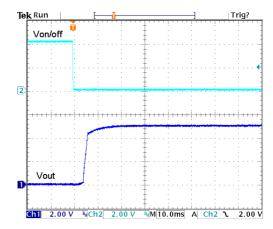
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

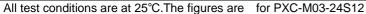


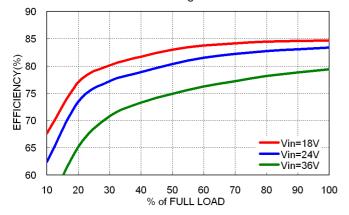
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



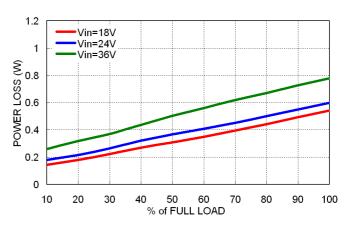
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



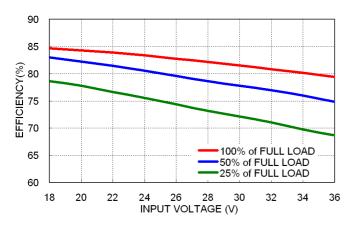




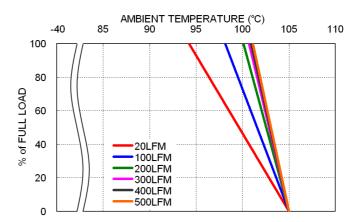
Efficiency versus Output Current



Power Dissipation versus Output Current



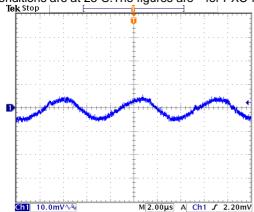
Efficiency versus Input Voltage Full Load



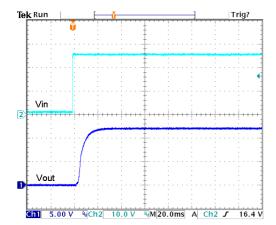
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



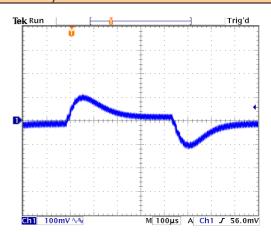




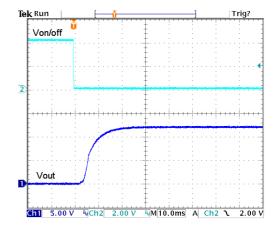
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

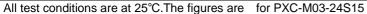


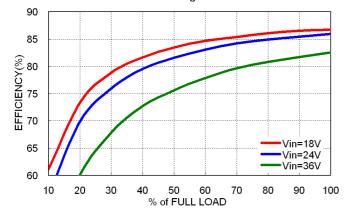
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



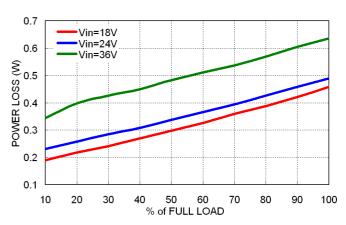
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



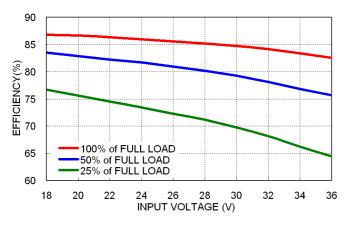




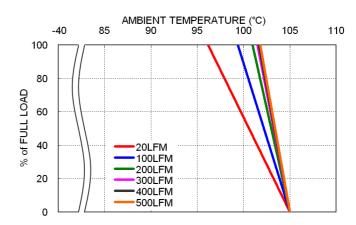
Efficiency versus Output Current



Power Dissipation versus Output Current

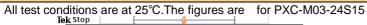


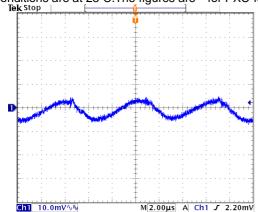
Efficiency versus Input Voltage Full Load



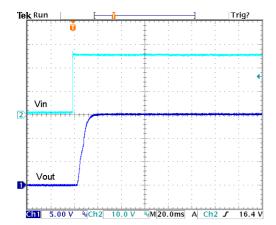
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



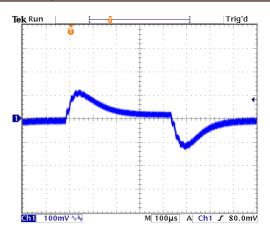




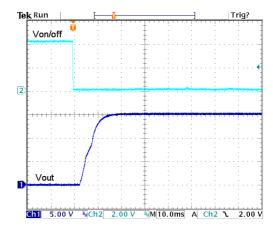
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

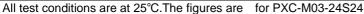


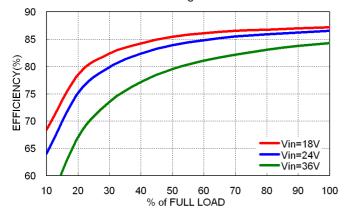
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



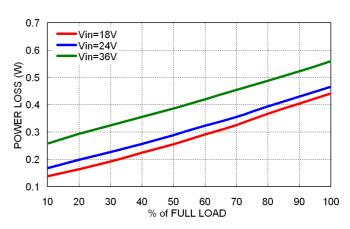
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



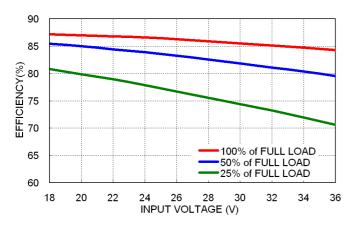




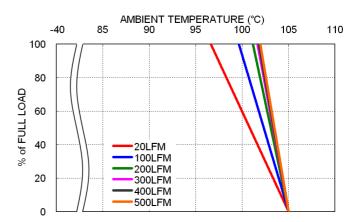
Efficiency versus Output Current



Power Dissipation versus Output Current

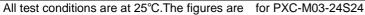


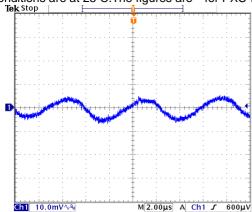
Efficiency versus Input Voltage Full Load



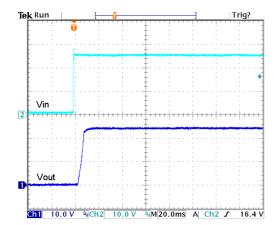
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



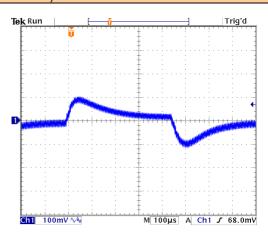




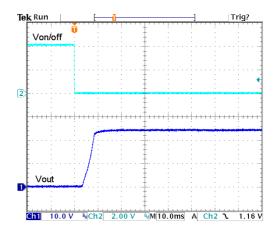
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

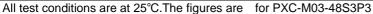


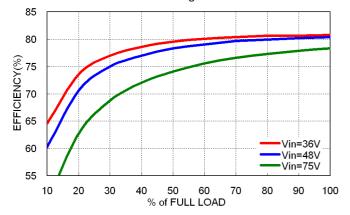
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



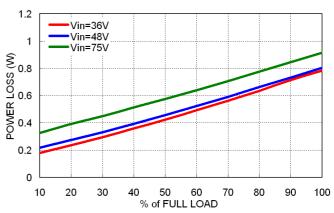
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



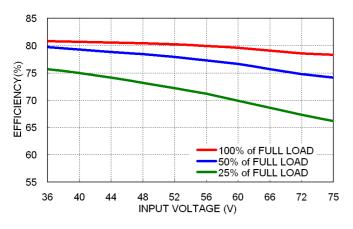




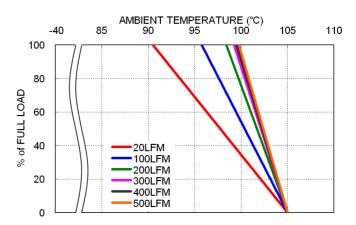
Efficiency versus Output Current



Power Dissipation versus Output Current

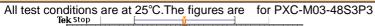


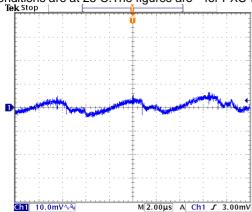
Efficiency versus Input Voltage Full Load



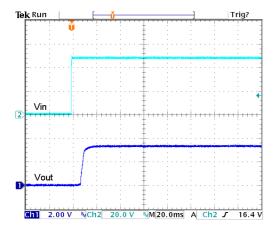
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



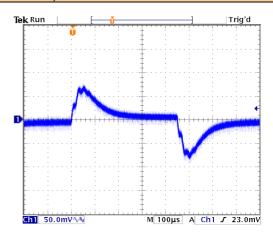




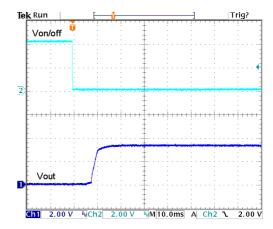
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

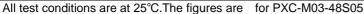


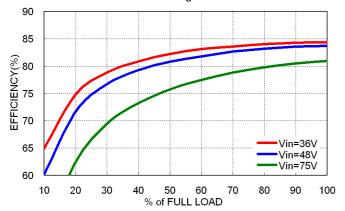
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



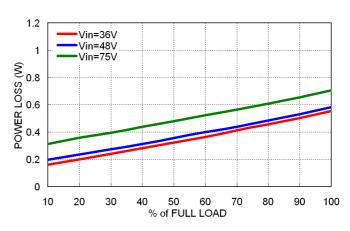
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



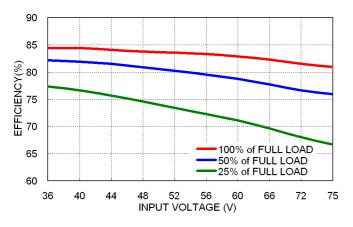




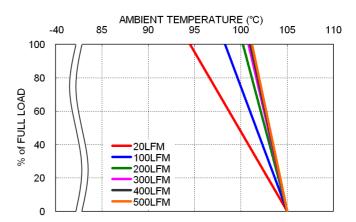
Efficiency versus Output Current



Power Dissipation versus Output Current

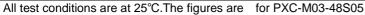


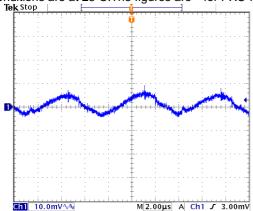
Efficiency versus Input Voltage Full Load



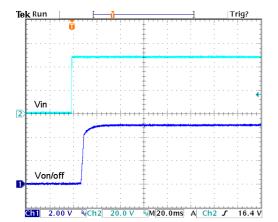
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



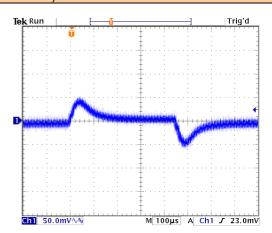




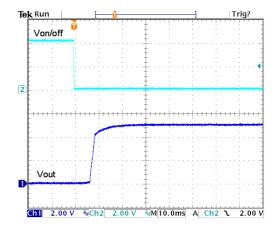
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

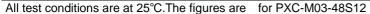


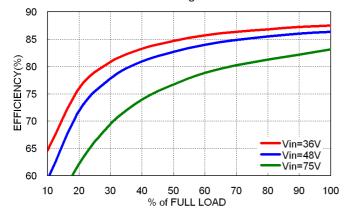
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



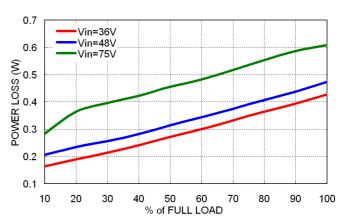
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



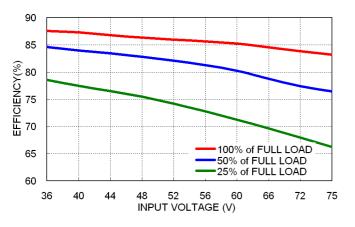




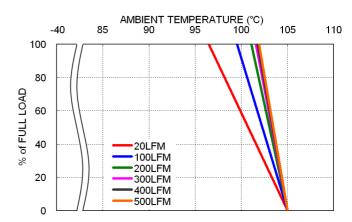
Efficiency versus Output Current



Power Dissipation versus Output Current



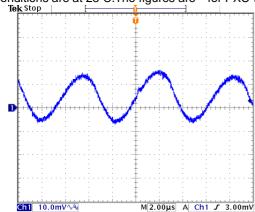
Efficiency versus Input Voltage Full Load



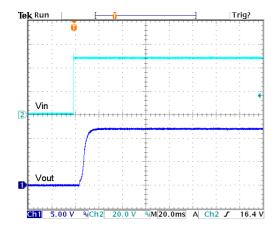
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



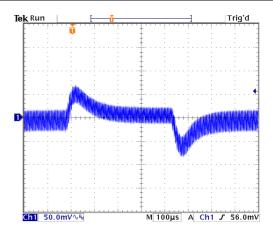
All test conditions are at 25°C. The figures are for PXC-M03-48S12



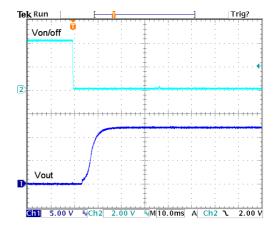
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

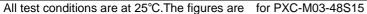


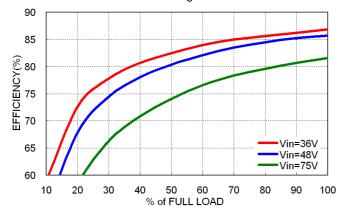
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



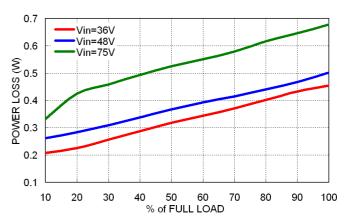
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



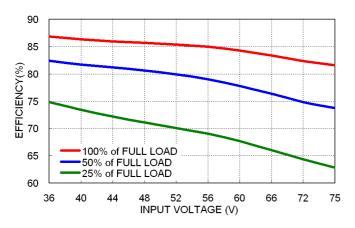




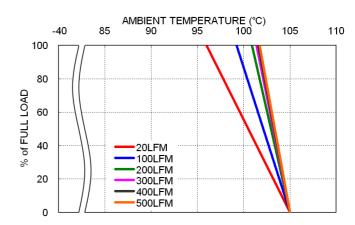
Efficiency versus Output Current



Power Dissipation versus Output Current



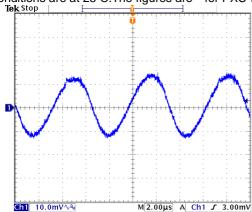
Efficiency versus Input Voltage Full Load



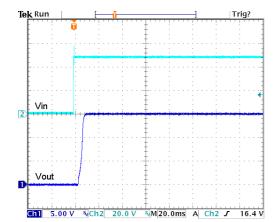
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



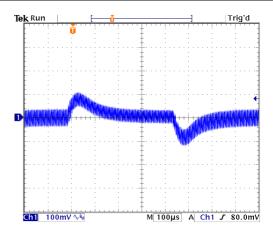
All test conditions are at 25°C. The figures are for PXC-M03-48S15



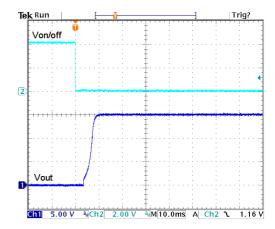
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load

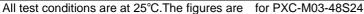


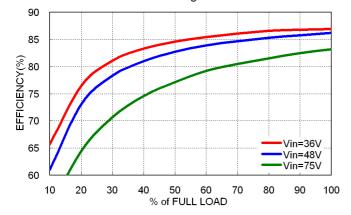
Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



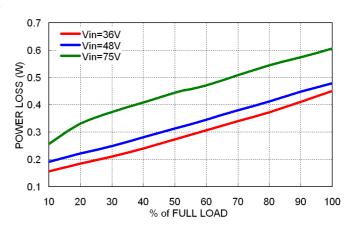
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load



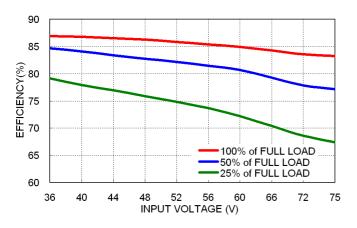




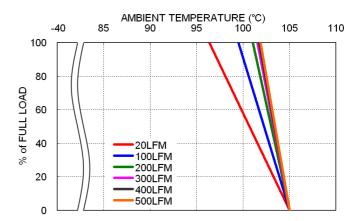
Efficiency versus Output Current



Power Dissipation versus Output Current



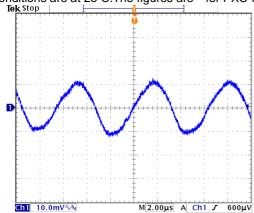
Efficiency versus Input Voltage Full Load



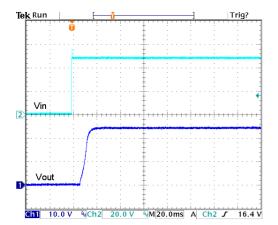
Derating Output Current versus Ambient Temperature and Airflow Vin(nom)



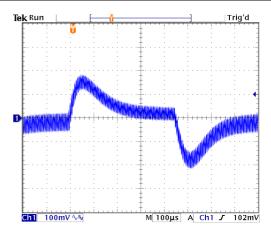
All test conditions are at 25°C. The figures are for PXC-M03-48S24



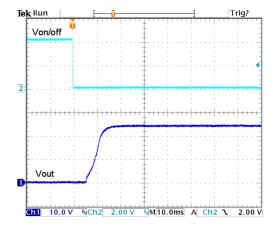
Typical Output Ripple and Noise. Vin(nom); Full Load



Typical Input Start-Up and Output Rise Characteristic Vin(nom); Full Load



Transient Response to Dynamic Load Change from 100% to 75% to 100% of Full Load; Vin(nom)



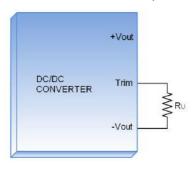
Using ON/OFF Voltage Start-Up and Output Rise Characteristic Vin(nom); Full Load

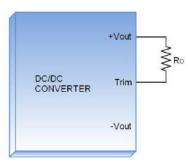


## Output Voltage Adjustment

Output voltage adjustment is an optional function for PXC-M03-xxSxx-xT.

It allows the user to increase or decrease the output voltage of the module. This is accomplished by connecting an external resistor between the TRIM pin and either the +Vout or -Vout pins. With an external resistor between the TRIM and (-) OUTPUT pin, the output voltage increases. With an external resistor between the TRIM and (+) OUTPUT pin, the output voltage decreases. The external TRIM resistor needs to be at least 1/16W of rated power.





TRIM-UP

Output voltage adjustment configurations

TRIM-DOWN

### TRIM TABLE

X	xS3P3	-xT	TRIM	1-UP								
Trim	า-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vo	out	(V)	3.333	3.366	3.399	3.432	3.465	3.498	3.531	3.564	3.597	3.630
R	:U	(kΩ)	385.837	191.894	127.246	94.922	75.527	62.598	53.362	46.436	41.049	36.739

#### TRIM-DOWN

Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	3.267	3.234	3.201	3.168	3.135	3.102	3.069	3.036	3.003	2.970
RD	(kΩ)	114.963	53.906	33.554	23.378	17.273	13.202	10.295	8.114	6.418	5.061

xx <b>S05</b>	-xT	TRIN	/I-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	5.048	5.098	5.148	5.198	5.248	5.298	5.348	5.398	5.448	5.498
RU	(kΩ)	252.301	125.126	82.734	61.538	48.820	40.342	34.286	29.744	26.211	23.385

## TRIM-DOWN

	Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
	Vout	(V)	4.948	4.898	4.848	4.798	4.748	4.698	4.648	4.598	4.548	4.498
Ī	RD	(kΩ)	248.499	120.674	78.066	56.762	43.980	35.458	29.371	24.806	21.255	18.415

xxS12	-xT	TRIM	1-UP								
Trim-Up	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	12.121	12.241	12.361	12.481	12.601	12.721	12.841	12.961	13.081	13.201
RU	(kΩ)	202.645	98.772	64.148	46.836	36.449	29.524	24.578	20.868	17.983	15.674

## TRIM-DOWN

	Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
ĺ	Vout	(V)	11.881	11.761	11.641	11.521	11.401	11.281	11.161	11.041	10.921	10.801
	RD	(kΩ)	777.155	381.028	248.985	182.964	143.351	116.943	98.079	83.932	72.928	64.126



## Output Voltage Adjustment (Continued)

## TRIM TABLE (Continued)

Σ	xx <b>S15-</b> x	Т	TRIN	1-UP								
Trim	ı-Up	(%)	2	4	6	8	10	12	14	16	18	20
Vo	out	(V)	15.305	15.605	15.905	16.205	16.505	16.806	17.106	17.406	17.706	18.006
R	U	(kΩ)	77.962	36.431	22.587	15.665	11.512	8.744	6.766	5.283	4.129	3.206

#### TRIM-DOWN

Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	14.855	14.705	14.555	14.405	14.255	14.105	13.955	13.805	13.654	13.504
RD	(kΩ)	818.776	401.838	262.859	193.369	151.675	123.879	104.025	89.135	77.553	68.288

xx <b>S24</b> -	-xT	TRIN	/I-UP								
Trim-Up	(%)	2	4	6	8	10	12	14	16	18	20
Vout	(V)	24.484	24.964	25.444	25.924	26.404	26.884	27.364	27.844	28.324	28.804
RU	(kΩ)	277.598	132.299	83.866	59.650	45.120	35.433	28.514	23.325	19.289	16.060

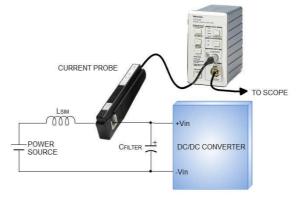
#### TRIM-DOWN

Trim-Down	(%)	1	2	3	4	5	6	7	8	9	10
Vout	(V)	23.764	23.524	23.283	23.043	22.803	22.563	22.323	22.083	21.843	21.603
RD	(kΩ)	4949.803	2440.402	1603.934	1185.701	934.761	767.467	647.972	558.350	488.645	432.880

#### Input Source Impedance

The power module should be connected to a low impedance input source. Highly inductive source impedance can affect the stability of the power module. Install choke (LSIM) to simulate the impedance of power source. External input capacitors CFILTER serve primarily as energy-storage elements, minimizing line voltage variations caused by transient IR drops in conductors from backplane to the DC/DC. The capacitor must as close as possible to the input terminals of the power module for lower impedance. The input reflected-ripple current measurement configuration is shown below:

### Input reflected-ripple current measurement setup



## PXC-M03-xxSxx

Component	Value	Voltage	Reference
Lsim	12µH		Inductor
CFILTER	47µF	100V	Nippon chemi-con KY-series



### **Output Over Current Protection**

When excessive output currents occur in the system, circuit protection is required on all power supplies. Normally, overload current is maintained at approximately 150 percent of rated current for PXC-M03 SERIES.

Hiccup-mode is a method of operation in a power supply whose purpose is to protect the power supply from being damaged during an over-current fault condition. It also enables the power supply to restart when the fault is removed. There are other ways of protecting the power supply when it is over-loaded, such as the maximum current limiting or current fold-back methods.

One of the problems resulting from over current is that excessive heat may be generated in power devices; especially MOSFET and Schottky diodes and the temperature of those devices may exceed their specified limits. A protection mechanism has to be used to prevent those power devices from being damaged.

The operation of hiccup is as follows. When the current sense circuit sees an over-current event, the controller shuts off the power supply for a given time and then tries to start up the power supply again. If the over-load condition has been removed, the power supply will start up and operate normally; otherwise, the controller will see another over-current event and shut off the power supply again, repeating the previous cycle. Hiccup operation has none of the drawbacks of the other two protection methods, although its circuit is more complicated because it requires a timing circuit. The excess heat due to overload lasts for only a short duration in the hiccup cycle, hence the junction temperature of the power devices is much lower.

The hiccup operation can be done in various ways. For example, one can start hiccup operation any time an over-current event is detected; or prohibit hiccup during a designated start-up is usually larger than during normal operation and it is easier for an over-current event is detected; or prohibit hiccup during a designated start-up interval (usually a few milliseconds). The reason for the latter operation is that during start-up, the power supply needs to provide extra current to charge up the output capacitor. Thus the current demand during start-up is usually larger than during normal operation and it is easier for an over-current event to occur. If the power supply starts to hiccup once there is an over-current, it might never start up successfully. Hiccup mode protection will give the best protection for a power supply against over current situations, since it will limit the average current to the load at a low level, so reducing power dissipation and case temperature in the power devices.

### **Output Short Circuitry Protection**

Continuous and auto-recovery mode.

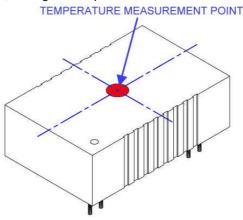
During short circuit, converter still shut down. The average current during this condition will be very low and the device can be safety in this condition.

#### **Output Over Voltage Protection**

The output over-voltage protection consists of circuitry that internally clamps the output voltage. If a more accurate output over-voltage protection scheme is required then this should be implemented externally via use of the remote on/off pin.

## Thermal Considerations

The power module operates in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat is removed by conduction, convection, and radiation to the surrounding environment. Proper cooling can be verified by measuring the point as shown in the figure below. The temperature at this location should not exceed 105°C. When operating, adequate cooling must be provided to maintain the test point temperature at or below 105°C. Although, the maximum test point temperature of the power module is 105°C, limiting this temperature to a lower value enhances the reliability.



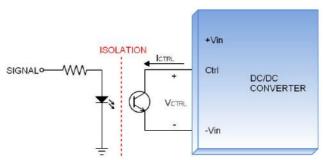


#### Remote On/off Control

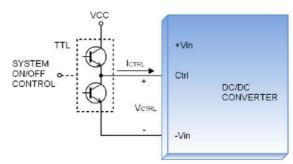
Only for B-type pin connection option with suffix -P,. Ex.: PXC-M03-24S05-P

The module is ON during logic Low and turns OFF during logic High. The Ctrl pin is an open collector/drain logic input signal that is referenced to (-)Vin. If not using the remote on/off feature, the Ctrl and (-)Vin pins should be connected together (shorted) or apply 0-1.2V between these two pins for the module to be ON.

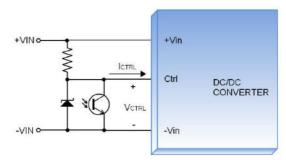
## Remote ON/OFF Implementation



Isolated-Control Remote ON/OFF



Level Control Using TTL Output

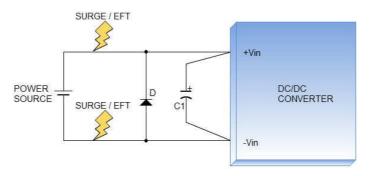


Level Control Using Line Voltage



# **EMS Considerations**

The PXC-M03 series can meet Fast Transient EN61000-4-4 and Surge EN61000-4-5 performance criteria A with external components connected to the input terminals of the module. Please see the following schematic.



#### **SURGE / Fast Transient**

## PXC-M03-05Sxx

Component	Value	Voltage	Reference
D	10A	45V	Vishay V10P45
C1	1000µF	25V	Nippon chemi-con KY-series

#### PXC-M03-12Sxx

Component	Value	Voltage	Reference
C1	470µF	50V	Nippon chemi-con KY-series

#### PXC-M03-24Sxx

Component	Value	Voltage	Reference
C1	470µF	50V	Nippon chemi-con KY-series

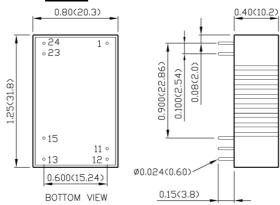
#### PXC-M03-48Sxx

Component	Value	Voltage	Reference
C1	330µF	100V	Nippon chemi-con KY-series

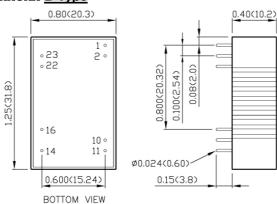


## Mechanical Data

## PXC-M03-xxSxx A Type



## PXC-M03-xxSxx B Type



## **PIN CONNECTION**

PIN	FUNCTION			
1	+ Vin			
11	No pin			
12	-Vout			
13	+Vout			
15	No pin			
23	- Vin			
24	- Vin			

1. All dimensions in Inch (mm)

2. Tolerance: X.XX±0.02 (X.X±0.5) X.XXX±0.01 (X.XX±0.25)

3. Pin pitch tolerance ±0.01 (0.25)

4. Pin dimension tolerance ±0.004 (0.1)

## PIN CONNECTION

PIN	FUNCTION
1	Ctrl (Option) / No pin*
2	- Vin
10	Trim (Option) / No pin*
11	No pin / NC**
14	+Vout
16	-Vout
22	+Vin
23	+Vin

\* If no Ctrl or Trim option, there is no pin on the corresponding pin number.

\*\* Pin 11 is "No pin" for

 $\mathsf{PXC}\text{-}\mathsf{M03}\text{-}\mathsf{xx}\mathsf{Sxx}\underline{\textbf{B}}\text{-}\underline{\textbf{T}}$ 

PXC-M03-xxSxx**B**-P**T** 

Pin 11 is "NC" for

 $\mathsf{PXC}\text{-}\mathsf{M03}\text{-}\mathsf{xx}\mathsf{Sxx}\underline{\textbf{B}}$ 

PXC-M03-xxSxx<u>B</u>-P

1. All dimensions in Inch (mm)

2. Tolerance: X.XX±0.02 (X.X±0.5) X.XXX±0.01 (X.XX±0.25)

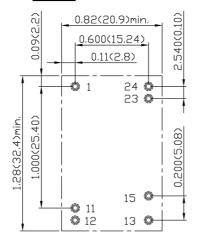
3. Pin pitch tolerance ±0.01 (0.25)

4. Pin dimension tolerance ±0.004 (0.1)

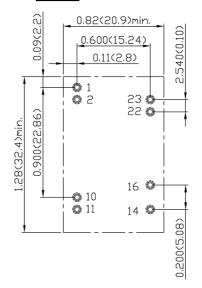


## Recommended Pad Layout

## PXC-M03-xxSxx A Type



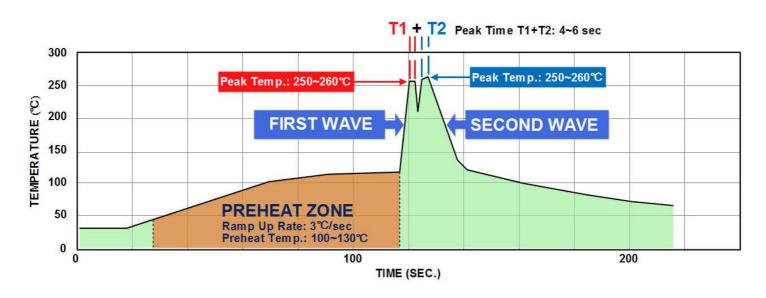
## PXC-M03-xxSxx B Type



- . All dimensions in Inch (mm)
  Tolerance: X.XX±0.02 (X.X±0.5)
  X.XXX±0.01 (X.XX±0.25)
- 2. Pin pitch tolerance ±0.01 (0.25)
- 3. Pin dimension tolerance ±0.004 (0.1)

## **Soldering Considerations**

Lead free wave solder profile



 $Reference\ Solder\ \colon\ Sn\text{-}Ag\text{-}Cu\ ;\ Sn\text{-}Cu$ 

Hand Soldering (Reference):
Soldering iron: Power 150W
Soldering time: 3~6 sec
Temp: 410~430°C



# **Packaging Information**

Tube

10pcs converters in a Tube All dimensions in inches (mm)

## Part Number Structure

PXC-M03 Series Name	-	48 Input Voltage (VDC)	S Output Quantity	05 Output Voltage (VDC)	Pin Connection Option	Remote On/Off Option	Trim Option
	•	<b>05</b> : 4.5~9 <b>12</b> : 9~18 <b>24</b> : 18~36 <b>48</b> : 36~75	S: Single	3P3: 3.3 05: 5 12: 12 15: 15 24: 24	A: A type □: B type	: No On/Off control P: Remote On/Off (Only for B type Pin connection)	
			D: Dual	05: ±5 12: ±12 15: ±15			

Model Number	Input Range	Output Voltage	Output Current @Full Load	Input Current @ No Load	Efficiency	Maximum Capacitor Load
	VDC	VDC	mA	mA	%	μF
PXC-M03-05S3P3A/□		3.3	1000	10	81	1050
PXC-M03-05S05A/□		5	600	10	84.5	750
PXC-M03-05S12A/□	4.5 ~ 9	12	250	15	85.5	130
PXC-M03-05S15A/□		15	200	15	87.5	100
PXC-M03-05S24A/□		24	125	20	85.5	39
PXC-M03-12S3P3A/□		3.3	1000	10	82	1050
PXC-M03-12S05A/□	9 ~ 18	5	600	10	84.5	750
PXC-M03-12S12A/□		12	250	10	87	130
PXC-M03-12S15A/□		15	200	10	87	100
PXC-M03-12S24A/□		24	125	10	87	39
PXC-M03-24S3P3A/□		3.3	1000	6	82	1050
PXC-M03-24S05A/□		5	600	6	84.5	750
PXC-M03-24S12A/□	18 ~ 36	12	250	6	87	130
PXC-M03-24S15A/□		15	200	6	87	100
PXC-M03-24S24A/□		24	125	6	87	39
PXC-M03-48S3P3A/□		3.3	1000	4	81	1050
PXC-M03-48S05A/□		5	600	4	83	750
PXC-M03-48S12A/□	36 ~ 75	12	250	4	87	130
PXC-M03-48S15A/□		15	200	4	86.5	100
PXC-M03-48S24A/□		24	125	4	86.5	39



## Safety and Installation Instructions

## **Fusing Consideration**

Caution: This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of sophisticated power architecture. For maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. See suggested values below:

Model	Fuse Rating (A)	Fuse Type
PXC-M03-05Sxx	1.25	Slow-Blow
PXC-M03-12Sxx	0.63	Slow-Blow
PXC-M03-24Sxx	0.315	Slow-Blow
PXC-M03-48Sxx	0.315	Slow-Blow

Based on the information provided in this data sheet on inrush energy and maximum dc input current at low Vin.

# MTBF and Reliability

The MTBF has been calculated using:

MIL-HDBK 217F NOTICE2 FULL LOAD, Operating Temperature at 25°C. The resulting figure for MTBF is 6.444×10<sup>6</sup> hours.

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